



Micron Laser Technology

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Part Number:

Micro Via Laser Drilling Subcontract Information Sheet

Company Name	<input type="text"/>	Requested Dock Date	<input type="text"/>
Address 1	<input type="text"/>	Ship method	<input type="text"/>
Address 2	<input type="text"/>	PO#	<input type="text"/>
Address 3	<input type="text"/>	Expedite #	<input type="text"/>
Contact	<input type="text"/>	Contact Phone #	<input type="text"/>

Down Rev. number:

Panel Count:

Images per panel:

Panel Construction Details

Dielectric Layers: Please list each different Depth/Diameter/Layer-Layer combination as a different tool

Layer-Layer	Diameter	Depth	Via Count	Dielectric + Reinforcement layer(s)

Copper Layers

Layer Number	Copper Thickness

Panel Orientation Information/Other Notes

Include a description of how to determine the top of the panel as well as the correct orientation for the laser drill files or attach a drawing showing correct orientation.

Revision Control

Include the drill file number for the applicable laser drill file for all jobs
For copper drill jobs, also include a Diazo(Target Layer Film) for each inner target layer.

Laser Drill Files: Layer 1	Layer 2
Front	<input type="text"/>
Back	<input type="text"/>
Positional Tolerance:	Dimensional Tolerance:
Diazo- First Target Layer	Diazo- Second Target Layer
Front	<input type="text"/>
Back	<input type="text"/>